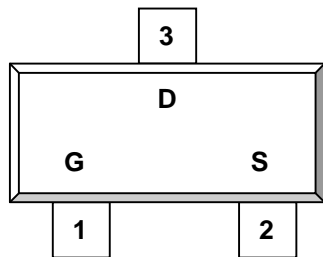


DESCRIPTION

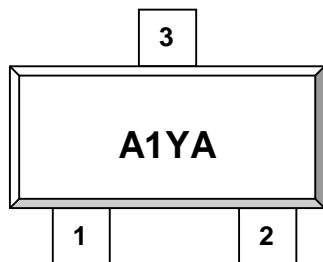
ST3401SRG is the P-Channel logic enhancement mode power field effect transistor which is produced using high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are required. The product is in a very small outline surface mount package.

PIN CONFIGURATION
SOT-23


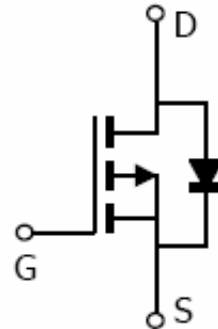
1. Gate 2. Source 3. Drain

FEATURE

- I -30V/-4.0A, $R_{DS(ON)} = 55m\Omega$ (Typ.) @ $V_{GS} = -10V$
- I -30V/-3.2A, $R_{DS(ON)} = 62m\Omega$ @ $V_{GS} = -4.5V$
- I -30V/-1.2A, $R_{DS(ON)} = 90m\Omega$ @ $V_{GS} = -2.5V$
- I Super high density cell design for Extremely low $R_{DS(ON)}$
- I Exceptional on-resistance and maximum DC current capability
- I SOT-23 package design

PART MARKING
SOT-23


Y: Year Code A: Process Code


ORDERING INFORMATION

Part Number	Package	Part Marking
ST3401SRG	SOT-23	A1YA

※ Process Code : A ~ Z ; a ~ z

※ ST3401SRG S : SOT-23 ; R : Tape Reel ; G : Pb – Free

STANSON TECHNOLOGY
120 Bentley Square, Mountain View, Ca 94040 USA
<http://www.stansontech.com>



-4.0A

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-30	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current (T _J =150°C)	I _D	T _A =25°C -4.0	A
		T _A =70°C -3.2	
Pulsed Drain Current	I _{DM}	-15	A
Continuous Source Current (Diode Conduction)	I _S	-1.0	A
Power Dissipation	P _D	T _A =25°C 1.20	W
		T _A =70°C 0.8	
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	120	°C/W



ST3401SRG



P Channel Enhancement Mode MOSFET

-4.0A

ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4		-1.0	V
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-24V, V_{GS}=0V$			-1	uA
		$V_{DS}=-24V, V_{GS}=0V$ $T_J=55^\circ C$			-10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \leq -5V, V_{GS}=-4.5V$	-10			A
Drain-source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-4.0A$		55	61	mΩ
		$V_{GS}=-4.5V, I_D=-3.2A$		62	70	
		$V_{GS}=-2.5V, I_D=-1.2A$		90	98	
Forward Transconductance	g_{fs}	$V_{DS}=-5V, I_D=-4.0V$		10		S
Diode Forward Voltage	V_{SD}	$I_S=-1.0A, V_{GS}=0V$			-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-15V$ $V_{GS}=-10V$ $I_D=-4.0A$		14	21	nC
Gate-Source Charge	Q_{gs}			1.9		
Gate-Drain Charge	Q_{gd}			3.7		
Input Capacitance	C_{iss}	$V_{DS}=-15V$ $V_{GS}=0V$ $F=1MHz$		540		pF
Output Capacitance	C_{oss}			131		
Reverse Transfer Capacitance	C_{rss}			105		
Turn-On Time	$t_{d(on)tr}$	$V_{DS}=-15V$ $V_{GS}=-15V$ $I_D=-1A$ $R_L=6\Omega$ $R_G=-10\Omega$		10	15	nS
				15	25	
Turn-Off Time	$t_{d(off)tf}$			31	50	
				20	30	

STANSON TECHNOLOGY
 120 Bentley Square, Mountain View, Ca 94040 USA
<http://www.stansontech.com>

STP3401SRG 2009. V1

TYPICAL CHARACTERISTICS (25°C Unless noted)

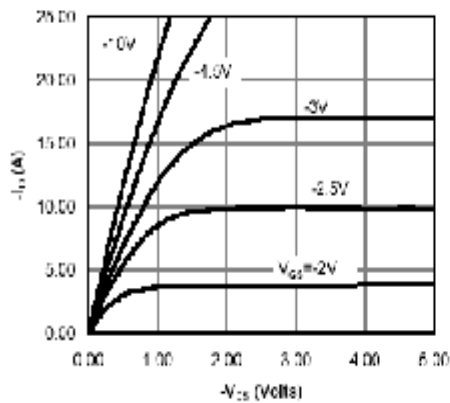


Figure 1: On-Region Characteristics

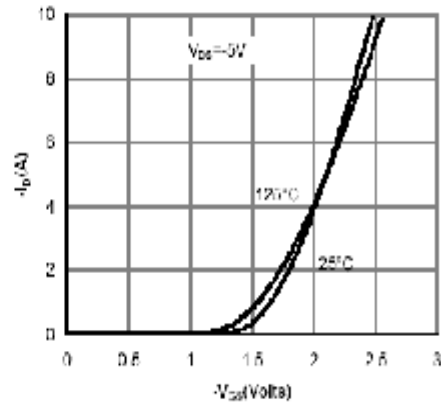


Figure 2: Transfer Characteristics

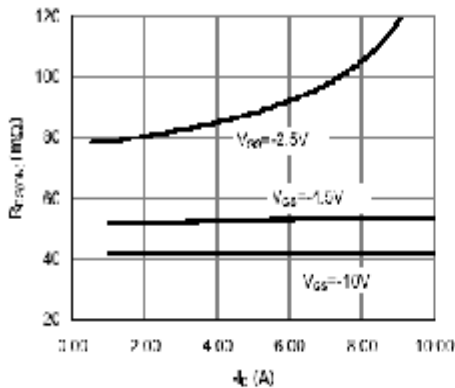


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

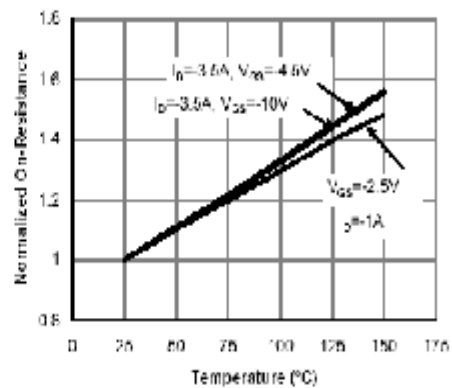


Figure 4: On-Resistance vs. Junction Temperature

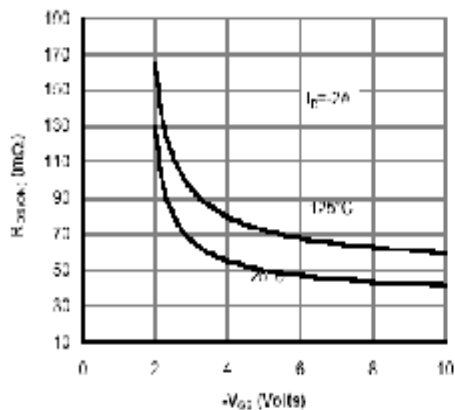


Figure 5: On-Resistance vs. Gate-Source Voltage

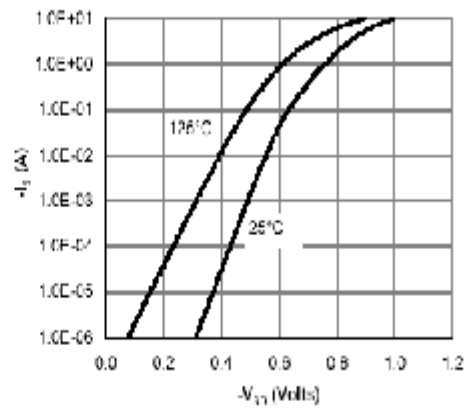


Figure 6: Body-Diode Characteristics

TYPICAL CHARACTERISTICS (25°C Unless noted)

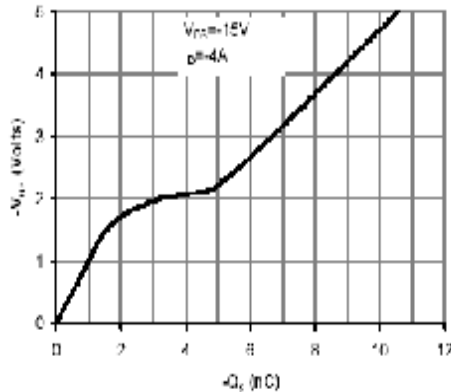


Figure 7: Gate-Charge Characteristics

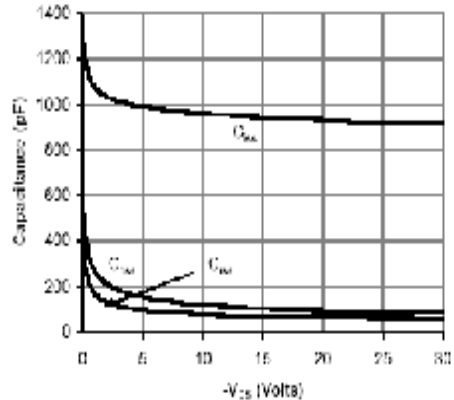


Figure 8: Capacitance Characteristics

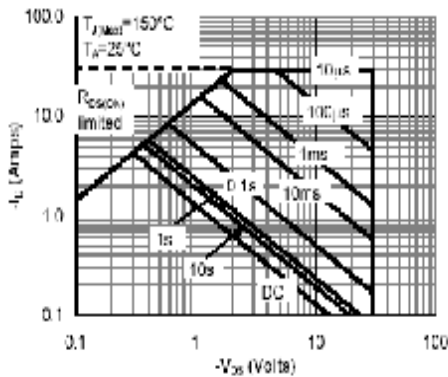


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

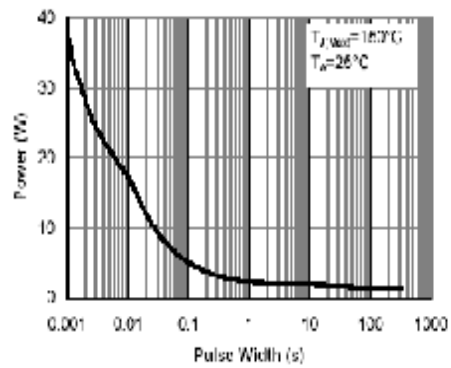


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note D)

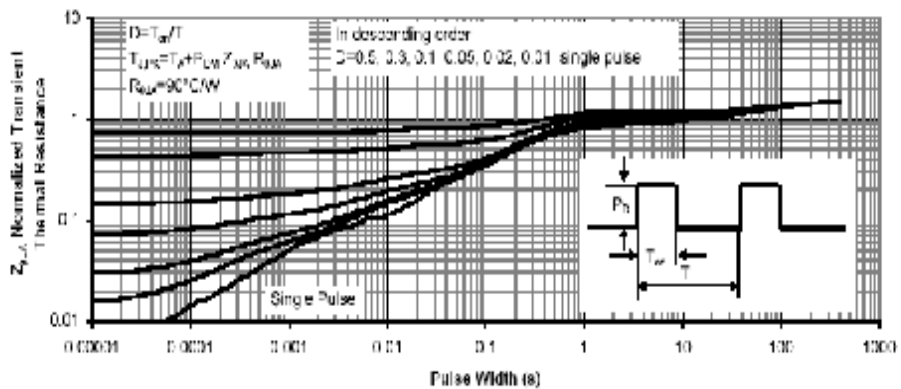
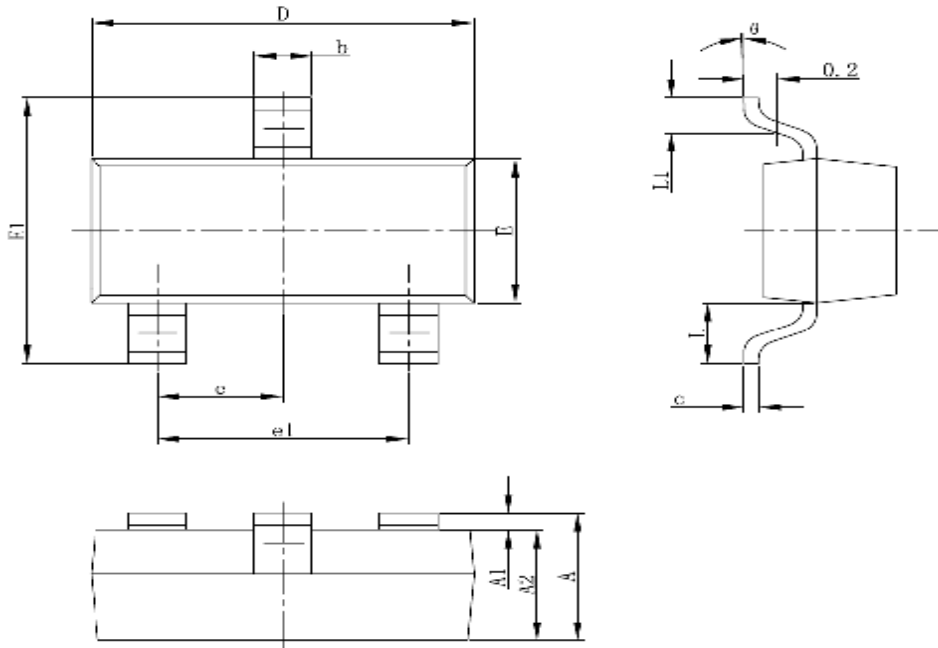


Figure 11: Normalized Maximum Transient Thermal Impedance

SOT-23 PACKAGE OUTLINE


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°